

Validation of a wireless modular monitoring system for structures

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ABSTRACT

A wireless sensing unit for use in a Wireless Modular Monitoring System (WiMMS) has been designed and constructed. Drawing upon advanced technological developments in the areas of wireless communications, low-power microprocessors and micro-electro mechanical system (MEMS) sensing transducers, the wireless sensing unit represents a high-performance yet low-cost solution to monitoring the short-term and long-term performance of structures. A sophisticated reduced instruction set computer (RISC) microcontroller is placed at the core of the unit to accommodate on-board computations, measurement filtering and data interrogation algorithms. The functionality of the wireless sensing unit is validated through various experiments involving multiple sensing transducers interfaced to the sensing unit. In particular, MEMS-based accelerometers are used as the primary sensing transducer in this study's validation experiments. A five degree of freedom scaled test structure mounted upon a shaking table is employed for system validation.

Keywords: Wireless sensors, wireless modular monitoring system, WiMMS, structural health monitoring, damage detection, sensing networks, performance-based monitoring, smart structures, smart transducers.

1. INTRODUCTION

The concept of monitoring civil structures is not new to the field of structural engineering. If the performance of structures can be monitored over their life spans, the result would be significant gains in the understanding of structural responses under normal and extreme loadings. To date, only a handful of structures, particularly those having been identified as special due to their critical importance in areas of high seismic activity, have been fully equipped with permanent monitoring systems. For example, in the state of California, the Department of Transportation has instrumented 900 sensing channels upon 60 long-span bridges throughout the state¹. The greatest barrier to the wide spread adoption of monitoring systems is their cost with installation of the system's wires often representing the greatest initial expenditure. In recent years, a large body of literature in the structural engineering field has been devoted to research associated with the concept of smart structures. Smart structures can best be described as structures that can monitor their responses to large disturbances, have the ability to limit the influence of these disturbances through structural control systems, and in instances of structural damage, be able to identify the existence of damage along with its location and extent. With structural monitoring systems representing the enabling technology of other smart structure technologies, their adoption represents a necessary first step. However, with the current high costs of monitoring systems, the gap that exists between smart structure concepts and implementation grows larger.

In an attempt to lower the high capital costs associated with wire-based monitoring systems, replacement of system wires with wireless technologies is proposed. This concept was first introduced in 1996 by Straser who proposed using wireless radios for the transfer of structural measurement data obtained from system sensors to a centralized data acquisition system in near real-time². With a significant amount of computational power included in the architectural core of a wireless sensing unit, Lynch, *et. al.*, has extended the concept of a wireless sensing unit for service as the

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primary building block of a real-time wireless modular monitoring system (WiMMS)³. Outside of structural engineering, Pister, *et. al.*, has focused upon the design of wireless smart transducers employing direct line-of-sight lasers for data transfer in military relevant applications including real-time battlefield management⁴. Within industry, the National Institute of Standards and Technology (NIST) and the Institute of Electrical and Electronics Engineers (IEEE) have been instrumental in issuing the IEEE1451 standard, an industry standard for plug and play communication between smart sensing transducers. The current IEEE1451 working group is expressing a desire to extend the IEEE1451 standard for explicit inclusion of wireless technology⁵.

A second paradigm change proposed is the inclusion of computational power within the wireless sensing unit. In traditional wire-based data acquisition systems, sensors are wired directly to a centralized data acquisition unit in a hub-spoke system architecture. Without computational power, sensors send their measurement data along the permanent communication channel to the centralized data acquisition unit whose responsibilities include data processing and data interrogation. In contrast, with computational power included in the wireless sensing unit, data processing can be conducted local to the sensor. The distribution of computational power throughout the system can facilitate efficient handling of the measurement data. An additional synergy exists between the proposed intelligence of the sensing unit and its wireless data channel with parallel processing of measurement data benefiting from the inherent flexibility of a wireless network connecting sensors through peer-to-peer communication.

A prototype sensing unit, designed to serve as the fundamental building block of the monitoring systems of the future, is designed and constructed. After construction, various validation tests are performed on the actual sensing unit in order to quantify its merits and limitations. Sensing transducers widely used in the structural engineering field are interfaced to the wireless sensing unit. To explore the benefit of using low-cost sensors, three different micro-electro mechanical system (MEMS) accelerometers are installed in a small-scale test structure to monitor the response of the structure to various disturbances. Local data interrogation capabilities are illustrated by using programmed numerical algorithms to identify the primary modes of response of the system.

2. DESIGN OF THE FUNDAMENTAL WIRELESS SENSING UNIT

The complete hardware design of the wireless sensing unit can be partitioned into three segments: the sensing interface, the computational core, and wireless communications (Fig. 1). The sensing interface is responsible for the interface of sensors to the wireless sensing unit and the conversion of their measurements to a digital format. The resulting digital measurements are then sent to the computational core where the overall operation of the wireless sensing unit is conducted. After the data has been logged and interrogated at the core, the data is packaged for transmission upon the wireless communication channel. In the following sections, each of these three functional groups of the proposed wireless sensing unit is discussed in greater detail.

2.1 Sensing interface

A large number of sensors can be employed for the purpose of monitoring structures. Accelerometers are a traditional choice for monitoring the global response of structures while strain gages and crack sensors are typically used for local response monitoring. To ensure a versatile and effective wireless sensing unit, the unit is designed to be sensor transparent by allowing the sensing interface to accept sensors that have analog outputs ranging in voltage from 0 to 5 volts. Transduction specifications unique to each sensor, such as conversion constants, can be coded into the computational core for the calculation of physical measurements from their analog voltage signals. A single channel, low-noise, Texas Instrument 16-bit analog-to-digital (A/D) converter is used for resolving to digital form, the analog output of a sensor. The high speed parallel CMOS architecture of the A/D allows for data sampling rates as high as 1000 kHz. Classical global response monitoring systems do not require sampling rates this high, but novel damage detection procedures based on local response data could require sampling rates in the kHz region.

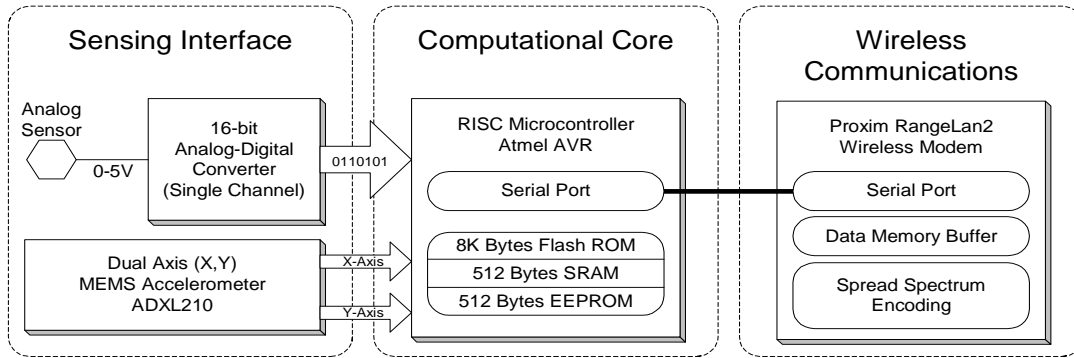


Fig. 1: Functional layout of proposed wireless sensing unit

In addition to the A/D converter, a dual axes MEMS-based accelerometer is permanently interfaced to the core's microcontroller. The Analog Devices' ADXL210 accelerometer was selected to interface directly to the system because it has the ability to output acceleration readings in a digital format that is easily readable by the computational core. Therefore, the acceleration output of the accelerometer's two orthogonal sensing axes serve as additional sensing channels included in the unit design, bringing the total number of data acquisition channels to three.

2.2 Computational core

The computational core of the wireless sensing unit represents the single most important design decision since its capabilities have a direct influence upon the performance and limitations of the entire unit. Three design factors govern the selection process of the computational core: computational capabilities, power consumption, and cost. A microcontroller which maximizes computation capabilities per unit power and cost is sought.

The final selection is an 8-bit microcontroller from the Atmel AVR family. This high-performance and low-power microcontroller is of a reduced instruction set computer (RISC) architecture providing 118 powerful assembly instructions that are executed on a single clock cycle. A maximum 8 million instructions per second (MIPS) throughput can be attained with this microcontroller. A suite of peripheral features provided on-chip includes timers, counters, analog comparators, and a programmable serial UART⁶. Sufficient memory is provided for storing the operational code of the computational core: 8K bytes of programmable flash memory, 512 bytes of static random access memory (SRAM) and 512 bytes of electronically erasable programmable read-only memory (EEPROM).

A convenient feature of the Atmel microcontroller is that its architectural design is optimized for use with high-level languages such as C and C++ when programming the microcontroller⁷. In general, high level languages employed for programming adds significant overhead in the microcontroller's code execution since the microcontrollers are optimized with the assumption that they would be programmed using assembly instructions. By providing 32 8-bit general purpose registers with 3 16-bit pointers, the Atmel AVR microcontroller reduces code overhead and allows for high code density when using high-level languages for programming. The large number of general purpose registers is necessary for allowing local variable definitions while the 3 16-bit pointers are useful for allowing indirect jumps and elegant data memory accessing.

2.3 Wireless communications

A reliable means of communicating measurement data from the wireless sensing unit to the network of wireless sensors is sought. While many wireless technologies exist in the marketplace, only those modems that employ spread spectrum techniques are considered. By avoiding the concentration of information on a single frequency, spread spectrum radios encode data over a wide frequency band. The low power, noise-like signals emitted from a spread spectrum transmitter are hard to intercept and jam making them robust and highly-reliable.

The Proxim RangeLAN2 radio modem is selected to serve as the wireless technology for the sensing unit. Operating on the 2.4 GHz unregulated FCC band, the RangeLAN2 communicates at a data rate of 1.6 Mbps. By employing a 1dBi

omni-directional antenna, open space communication ranges of 1000 feet can be attained while inside structures, this range would be reduced to approximately 500 feet with the range varying as a function of the type of building construction⁸. Powered by a 9 V direct current (DC) voltage source, the modem draws 160mA of current during receive and transmit communications, but its current draw can be reduced to 60mA when the modem is placed in sleep mode. Sleep mode is important if a battery is employed since this convenient feature can extend the life of the battery.

2.4 Integration and packaging

With the key hardware components selected, the system is integrated in one package. The integrated circuit components such as the microcontroller, A/D converter and additional support circuitry are mounted upon a two layer circuit board designed using a noise minimization approach. The RangeLAN2 radio gear is externally attached to the circuit board through an RS232 serial cable. The entire packaging is powered by a 9 V alkaline battery power supply. The dimensions of the system are 4 inches long, 4 inches wide, and 2 inches deep (Fig 2).

3. WIRELESS SENSING UNIT PERFORMANCE VALIDATION

With the design of the wireless sensing unit complete and a prototype fully constructed, it is necessary to perform a series of validation tests to ensure suitable performance for structural monitoring applications. The first set of validation tests intend to evaluate the performance of the individual wireless sensing unit. The duration of the unit's power source, the resolution of the A/D converter, and the maximum permissible sample rate for data acquisition are to be determined.

3.1 Battery life span

The sensing unit requires a 9 volt DC power source. One potential source of power can originate from a portable power source such as a 9 volt battery. However, the amount of power contained in a battery source is finite and will eventually run out if not recharged or replaced. Based on the electrical characteristics of the various sensing unit components, the expected operating life of the system's power source can easily be calculated. For example, the Proxim RangeLAN2 draws 160mA when transmitting data and 60 mA when placed in sleep mode. The data sheet of a Duracell 9 V alkaline-manganese dioxide battery provides a log-log engineering design chart of the battery's service life versus discharge current⁹. Considering the driving current of the RangeLAN modem and consulting the engineering chart of the battery, the life span of the 9 V battery when the modem is transmitting data is roughly 2 hours while in sleep mode, the battery can last roughly 4 hours. Considering the electrical characteristics of the various integrated circuits chosen such as the microcontroller and A/D converter, the approximate current draw of the unit's circuit is 27 mA. When a 9 V Duracell battery is selected to power the circuit, the expected operational life span of the battery is as high as 20 hours.

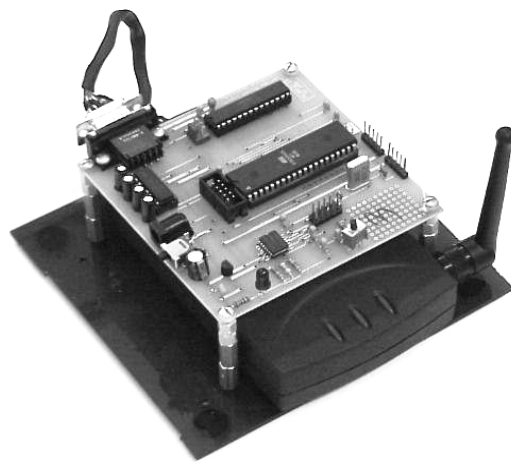


Fig. 2: Fully functional wireless sensing unit prototype

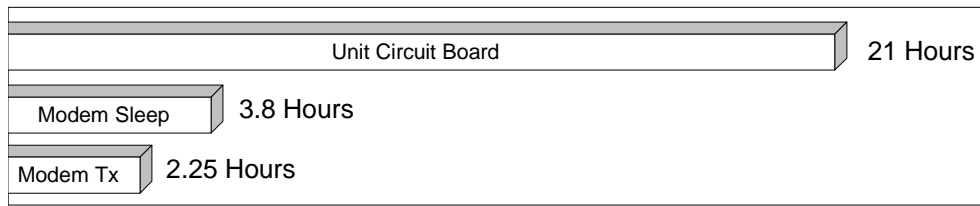


Fig. 3: Operational life span of the wireless sensing unit's components when powered by a 9V battery

To validate these calculations of the expected operational life of the sensing unit, the sensing unit is operated using a Duracell 9 V battery with the operational life of the battery monitored (Fig. 3). The results of the battery test are in good agreement with the initial life span estimates. The short life span of the 9V battery, especially during the operation of the radio modem, underscores the fact that power is an important design issue of the prototype and should be revisited in the future. While outside the scope of this study, more efficient batteries do exist in the marketplace that can be used in lieu of the 9 V alkaline batteries to provide a significantly longer lasting 9 V DC power source. Renewable nickel cadmium battery sources, coupled with a mechanism of recharging, can also be considered in future sensing unit designs.

3.2 A/D Resolution

The A/D converter is located on the unit's two-layer circuit board, sharing power and grounding lines with the other integrated circuit components including analog and digital logic components. When digital and analog integrated circuits share a common ground, ordinary switching of the digital logic can have a detrimental influence on the performance of the analog circuit¹⁰. The analog portion of the A/D converter, with a starting conversion resolution of 16 bits, is susceptible to some amount of corruption of the analog signal input due to the digital switching elsewhere in the circuit. The result is seen as a reduction in the digital resolution of the A/D converter. To test for this reduction, a high-performance regulated power supply is used to hold a constant voltage at the sensor input of the A/D converter. The power supply used is a Hewlett Package E3610A with an output ripple and noise of only 200 μ V. Assuming the full resolution of 16 bits in the conversion, the noise in the regulated power supply output would result in the chattering of the two least significant bits of the digital conversion. The output of the A/D converter has noise greater than that of the power supply, representing a manifestation of the A/D converter's reduced resolution (Fig. 4). The conversion noise is relatively white, with a standard deviation of ± 5 bit counts, representing a resolution of approximately 13 bits.

3.3 Data acquisition sample rate

The wireless sensing unit can be used for both real-time and near real-time monitoring applications. For near real-time applications, the sensing unit is programmed to locally accumulate data at a given rate and to store that data for later retrieval. When the data collection is complete and the sensor data stored in memory, the unit can transmit that data to the other wireless sensing units in the sensing network upon demand. The delay in archiving and transmitting the sensor

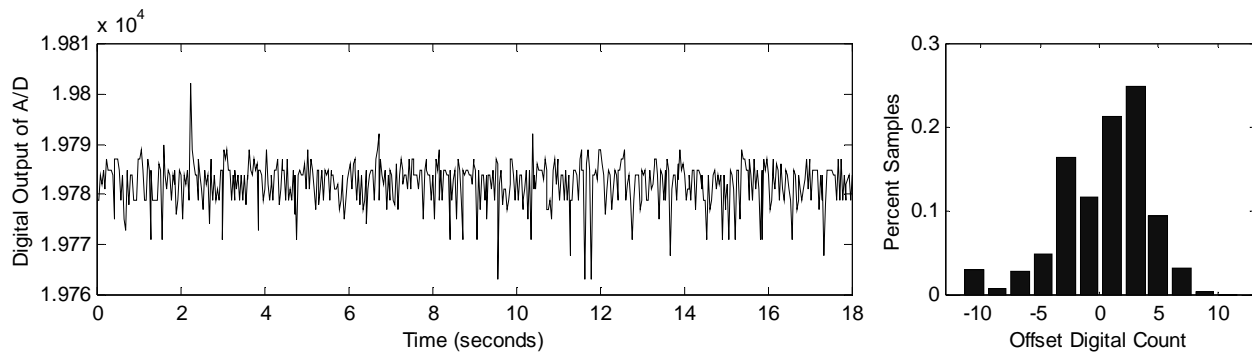


Fig. 4: Performance of the A/D converter – Constant voltage of 1.5V applied

data results in this approach being classified as near real-time. In contrast, for real-time applications, the microcontroller is responsible for transmitting data at a precise clock time. In real-time data acquisition applications, the data is still archived locally in memory.

Prior to implementation, the sample rate of the wireless sensing unit can be set to a desired value depending upon the monitoring application. In both modes of operation, there exist maximum sampling rates that the sensing unit can achieve. For real-time applications, time is required to encode each data point within a packet protocol specific to the RangeLAN2 radio modem. Once assembled in the microcontroller, more time is required to send the packet through the serial port to the radio. A baud rate of 19200 is used where the baud rate represents a direct measure of the maximum number of times a digital signal can vary per second on a single electrical line. Once the packet is buffered in the RangeLAN2 packet buffer, additional time is required to employ spread spectrum techniques for the transmission of the packet. Validation tests are performed, indicating that this entire process results in a maximum real-time sampling rate of 33 Hz. If a sampling rate is chosen greater than the 33 Hz threshold, data points can be lost during transmission. For near real-time applications, only the time required to attain and save the data in memory limits the maximum sampling rate. Empirical tests indicate that for near real-time, a maximum sampling rate of 20 kHz can be attained.

4. MEMS-BASED ACCELEROMETERS

Complementing the low-cost nature of the proposed wireless sensing unit, the feasibility of interfacing inexpensive and compact sensors to the unit is of particular interest. The field of micro-technologies is fabricating small micrometer sized mechanical transducers upon the same silicon die used for integrated circuits, yielding low cost and precise MEMS sensors in form factors unimaginable years ago. Given the wide spread popularity of using accelerometers to monitor the global response of structural systems to dynamic loads, MEMS-based accelerometers are selected from available MEMS sensors. Two distinctly different MEMS accelerometer architectures are considered in this study: capacitive and piezoresistive designs. The Analog Devices ADXL210 and Bosch SMB110 accelerometers are selected from the family of capacitive designs while a new piezoresistive accelerometer is designed and fabricated for this study.

4.1 Capacitive architectures

Employing advanced photolithography and etching techniques during manufacturing, a three dimensional polysilicon structure consisting of a released proof mass can be fabricated¹¹. The proof mass is connected to the silicon substrate through linear springs. Capacitive plates are etched into the perimeters of both the proof mass and substrate forming balanced differential capacitors that are used to directly measure acceleration (Fig. 5). The substrate's capacitor plates are driven 180° out of phase with voltage square waves. As the capacitive plate of the proof mass displaces between the two plates of the substrate, it unbalances the differential capacitor resulting in a square wave signal whose amplitude is proportional to the displacement. A synchronous demodulator is then used to generate an analog signal from the differential capacitor proportional to the acceleration of the sensor. The characteristics of the accelerometer's performance such as bandwidth and resolution can be set by connecting a capacitor on the analog output completing a first-order RC low pass filter. In general, a tradeoff exists between the bandwidth and resolution of the accelerometer with greater bandwidths causing reduced resolution. The noise inherent in capacitive accelerometers is characteristically Gaussian and is therefore constant over the entire bandwidth of the sensor.

In the capacitive accelerometer family, two accelerometers are considered for integration with the sensing unit. The Bosch SMB110 and Analog Devices ADXL210 are selected. Variations exist in the design of the two accelerometers. In particular, the SMB110 is a single axis accelerometer while the ADXL210 measures acceleration in two planar axes. It was already noted that an ADXL210 sensor is directly interfaced to the microcontroller, but for this study's validation tests, an additional ADXL210 is externally connected through the A/D converter. When interfaced directly to the microcontroller, the advantage of using the optional digital output of the ADXL210 accelerometer is exploited. The ADXL210 encodes its acceleration measurements within the duration of the high portion of a continuous square wave. This digital technique is called duty cycle modulation. The resolution of this duty cycle modulated signal is 14-bit and anti-aliased. The performance properties of the two capacitive accelerometers are summarized in Table 1.

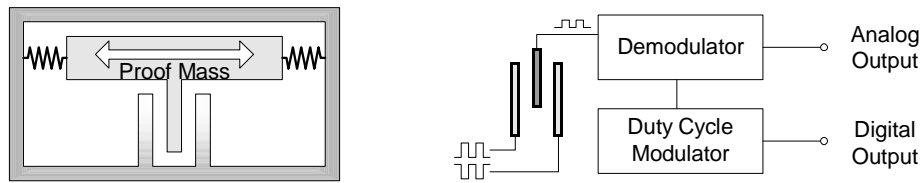


Fig. 5: Conceptual design of capacitive architecture accelerometers

Table 1: Performance comparison of capacitive accelerometers

Properties	Analog Device ADXL210 ¹²	Bosch SMB110 ¹³
Range	$\pm 10g$	$\pm 2.3g$
Sensitivity	100 mV/g	780 mV/g
Offset	2.5 V	2.5 V
Operating Voltage	5 V	5 V
Resolution	4 mg _{RMS}	6.79 mg _{RMS}
Bandwidth	50 Hz	56.4 Hz

4.2 High-performance planar piezoresistive architecture

Piezoresistive materials change resistance when placed under tensile and compressive strain. This property has been exploited for well over 20 years in the design of piezoresistive accelerometers¹⁴. Classical piezoresistive accelerometers are generally used for out-of-plane acceleration with a proof mass connected to a short flexure upon which a piezoresistive material has been implanted. A new high-performance design of a piezoresistive accelerometer for measurement of in-plane acceleration is proposed by Professor Kenny's group at Stanford University¹⁵. An accelerometer with a planar cantilevered proof mass is fabricated upon a silicon die using deep reactive ion etching (DRIE) techniques. The cantilever is a single short flexure that is slender in the in-plane direction limiting the out-of-plane response of the proof mass. Oblique ion implantation is used for the formation of piezoresistors upon the side walls of the cantilevering element where a region of highly focused strain exists (Fig 6). A Wheatstone bridge, intended for temperature compensation of the piezoresistive implants, is embedded in the die to complete the accelerometer design. Over the full dynamic range, the accelerometer exhibits nearly constant sensitivity resulting in a linear transfer function of the sensor.

Performance characteristics of the high-performance piezoresistive accelerometer can be tuned to a specific application through the resizing of the cantilever dimensions. For example, to maximize the sensor's sensitivity, the width of the flexure should be minimized while the radial length of the proof mass maximized. Similar to the capacitive architecture, there exists a design tradeoff between the sensor's bandwidth and resolution; for greater resolution, the resonant frequency and bandwidth decrease. The maximum range of the accelerometer is determined by how far the proof mass can transverse before it is arrested by its housing. This arresting design ensures the survivability of the accelerometer

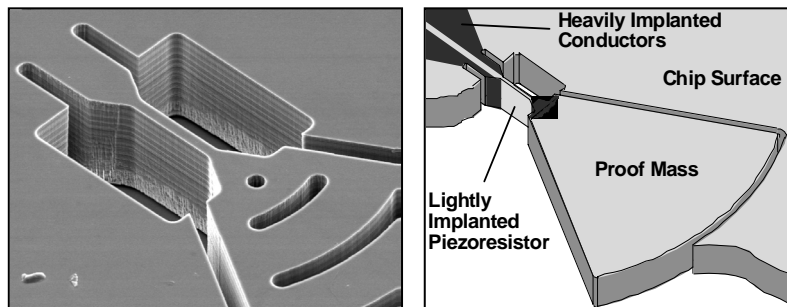


Fig. 6: SEM micrograph and design illustration of the high-performance planar accelerometer

when mechanically shocked. This is a major advantage of the accelerometer since the capacitive designs sustain damage when shocked. The end stops of the proof mass also prevent the flexural element from entering a nonlinear response regime.

Two dominant noise sources are present in the accelerometer design. In lower frequency regions, roughly below 100 Hz, noise is attributed to the inverse frequency ($1/f$) Hooge electrical noise of the piezoresistive elements¹⁶. Above approximately 100 Hz, Johnson noise is the dominate noise source and is constant over the applicable frequency region. Johnson noise is a direct result of the thermal agitation of electrons in a conductive element.

When compared against commercially available piezoresistive accelerometers, the experimental results of the high-performance piezoresistive accelerometer is superior. One set of accelerometers are designed and fabricated for specific adoption within the wireless structural sensing unit. These particular accelerometers have a radial length of 1 mm and a flexural width of 5 μm . The full dynamic range of the accelerometers is well above 10g with a resolution of 20 μg at an acceleration bandwidth of 650 Hz.

4.3 Accelerometer performance validation

The three accelerometers are interfaced to the wireless sensing unit for validation of their performance specifications. In particular, the sensitivity and resolution of the sensors are to be validated experimentally. Sensitivity is calculated by placing the accelerometers upon a vibration isolated laboratory surface in the 0g and 1g gravity fields. The change in mean voltage of the two readings provides the sensitivity measure (Fig. 7). The ADXL210 experiences a change of 103.3 mV when displaced from a 0g to a 1g position. Hence, the sensitivity of the accelerometer is 103.3 mV/g. Likewise, the SMB110 and high-performance piezoresistive accelerometer (HPPA) exhibit sensitivities of 794.2 mV/g and 92.5 mV/g respectively. The sensitivity values of the capacitive accelerometers are in very good agreement with their datasheet values. The sensitivity of the SMB110 is larger than that of the ADXL210 and the HPPA because it has a small acceleration range (2.3 g) while the other two have greater ranges (10 g).

The steady state time history readings of the accelerometers acquired from the sensitivity tests are used to characterize the resolution of the sensors. The zero gravity readings are used to calculate the root mean square of the deviation of the signals from their means. This measurement serves as a suitable means of quantifying the noise inherent in the acceleration readings of the capacitive accelerometers (Fig. 8). Provided that the noise in the high-performance accelerometer is not necessarily Gaussian, the root mean square value of the signal noise is still a convenient vehicle of quantifying the noise in the sensor. The noise distributions of both capacitive accelerometers portray a very Gaussian distribution with root mean square values of 6.4 mg and 9.4 mg respectively. For the ADXL210 accelerometer, this deviation is down near the resolution of the A/D converter. The 9.4 mg deviation of the SMB110 signal is in good agreement with that stated in the datasheet. The noise distribution of the high-performance piezoresistive accelerometer is not as Gaussian as the capacitive accelerometers and exhibits greater noise as represented by its root mean square

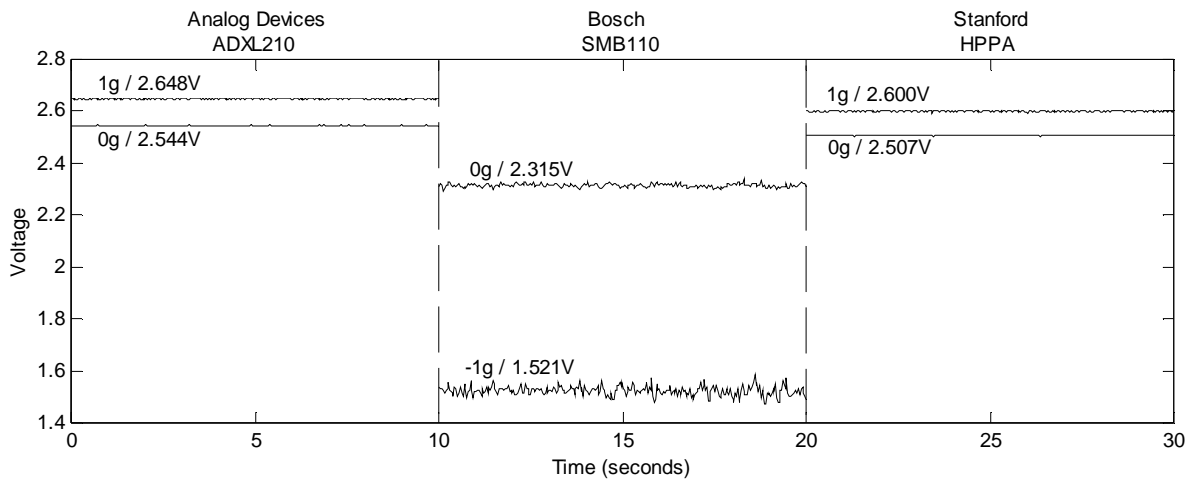


Fig. 7: Sensitivity calibration test results

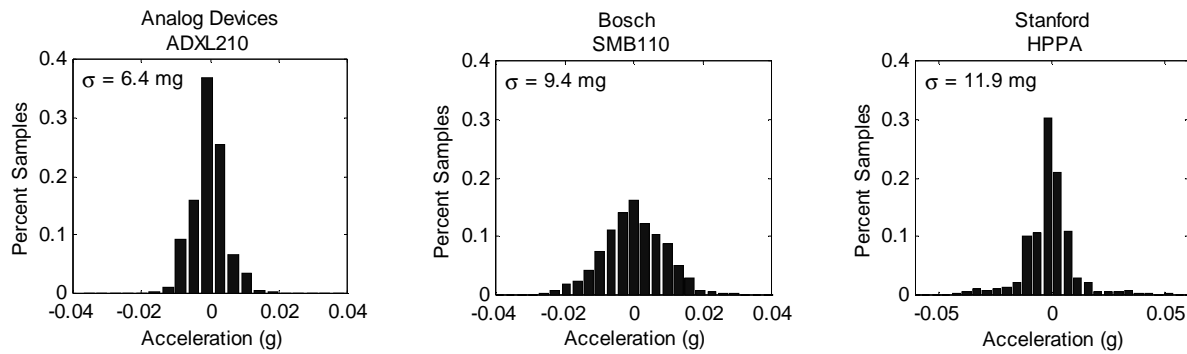


Fig. 8: Histogram of noise in accelerometer steady state signals

value of 11.9 mg. In applications where accelerations are characterized by high frequency content, the noise in the high-performance piezoresistive accelerometer will be better than that of the capacitive accelerometers¹⁵.

5. STRUCTURAL MONITORING VALIDATION

To validate the performance of the wireless sensing unit in a structural monitoring setting, a validation test upon a test structure is devised. A five-story shear frame structure, made from aluminum, is designed and constructed (Fig. 9). The lateral stiffness of each floor originates from the four vertical aluminum columns roughly 0.5 inches by 0.25 inches in cross sectional area. Each floor weighs 16 pounds. From log-decrement calculations of free vibration tests, the damping of the structure is approximated to be 0.5% of critical damping. The wireless sensing unit is securely fastened to the fourth story while the three MEMS-based accelerometers are mounted upon the fifth story. The entire structure is fastened to the top of a lateral shaking table driven by a 11 kip actuator. Various excitations are applied at the base of the structure to dynamically excite the system.

For this set of validation tests, two goals are sought. First, the use of MEMS-based accelerometers in conjunction with

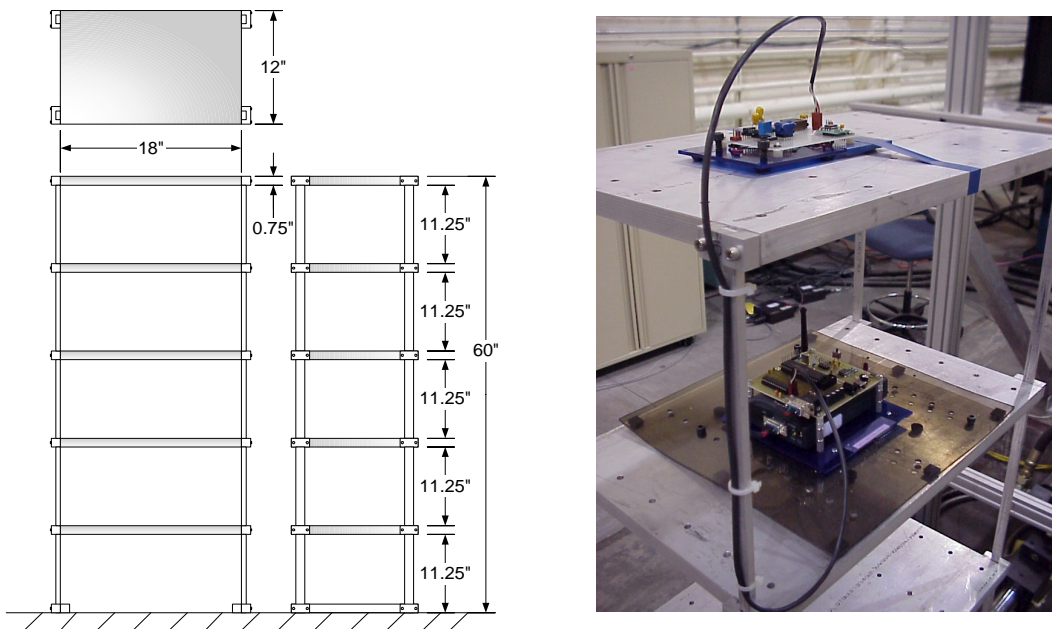


Fig. 9: Five-story aluminum test structure – wireless unit located on floor 4 and accelerometers on floor 5

the wireless sensing unit for measuring the real-time response of a structure is to be illustrated. Secondly, the concept of local processing of measurement data in near real-time within the wireless sensing unit is to be validated.

5.1 Real-time structural response monitoring

A swept-frequency sine, also known as a chirping excitation, is applied to the base of the structure in order to excite the lower modes of response of the system. The chirping excitation has a constant displacement amplitude of 0.075 inches with a linearly varying frequency of 0.25 to 3 Hz over 60 seconds. During the excitation, the acceleration response of the fifth story is monitored using all three accelerometers mounted to the structure. The measurement data is sampled at 30 Hz, well above the primary modes of response of the system analytically determined to be 2.96, 8.71, 13.70, 17.47, and 20.04 Hz. The response of the structure to the input excitation is in very good agreement with the theoretical response determined analytically (Fig. 10). The amplitude envelope of the measured acceleration response is nearly identical to that of the theoretical response while the frequency of the measured response is slightly out of phase with the theoretical response (Fig. 11). This minor discrepancy can easily be attributed to the test structure not behaving exactly within the assumptions of the over generalized analytical system.

5.2 Local data interrogation

Attention is now turned to the validation of embedding data interrogation schemes within the computational core of the wireless sensing units. For this task, 64 Kbytes of additional static random access memory (SRAM) is externally attached to the wireless unit for logging of the measurement data. Provided that each data point is comprised of three bytes (one byte for ordering of the data point and two bytes for the measurement), well over 20,000 data points can be held in the SRAM at one time. Within the computational core, a fast Fourier transform (FFT) routine is executed on the time history data. Once a measurement time history is recorded into memory, the fast Fourier transform is executed on the time history data. The resulting frequency response function is then wirelessly transmitted to the centralized data logging unit for further analysis such as the identification of the primary modes of response of the system. While numerous interrogation schemes can be considered, many damage detection methods for structures are based upon shifts in the frequency of the natural modes of response of the system¹⁸. Therefore, calculating the frequency response function represents the first step towards embedding sophisticated damage detection schemes within the wireless sensing units.

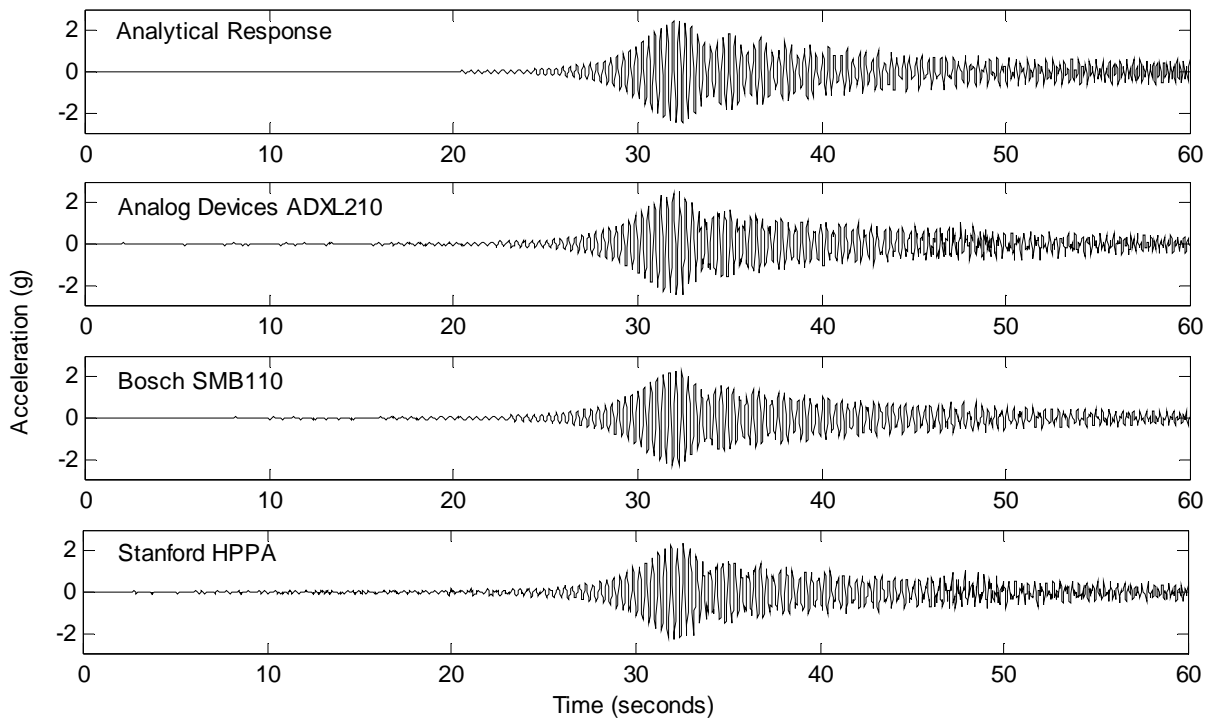


Fig. 10: Fifth-story acceleration response of test structure (Sampling rate of each acquisition channel is 30 Hz)

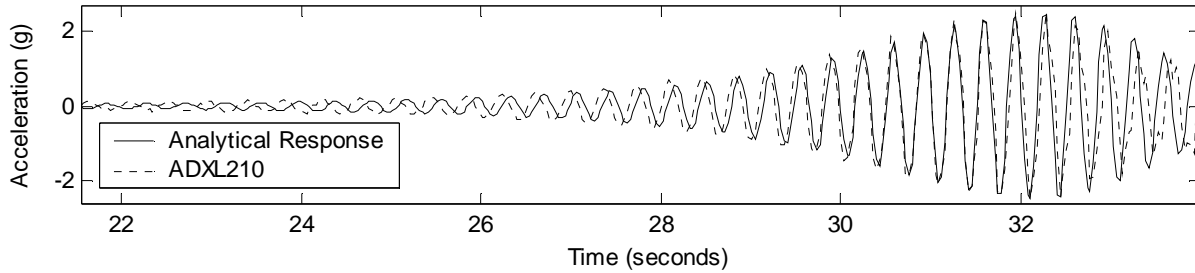


Fig. 11: Fifth-story acceleration response of test structure (Sampling rate of each acquisition channel is 30 Hz)

For the wireless sensing unit attached to the test structure, the frequency response function of the three recorded time histories is calculated locally from an embedded FFT algorithm (Fig. 12). The first three modes of response of the structure can easily be identified from the calculated response functions. The modes are identified to be 2.87, 8.59, and 13.54 Hz. The frequencies of the calculated modes are within 3% of those calculated from the theoretical model. At 12.84 Hz there appears to be an additional mode that can be attributed to a torsion response mode resulting from minor geometric imperfections in the model construction. The frequency response function from the high-performance piezoresistive accelerometer is noisier than those calculated from the capacitive accelerometers. This was expected because of the dominance of the $1/f$ Hooge noise inherent to the accelerometer's design at low frequencies.

6. CONCLUSION

In this paper, a low-cost wireless sensing unit for deployment in structural systems is presented. The fundamental and enabling technology of the WiMMS concept is the individual wireless sensing unit. A robust design of the unit incorporating some of the most current technologies the marketplace has to offer has been achieved. To gauge the performance characteristics of the wireless sensing unit, various validation tests were performed. First, validation tests designed to investigate the individual performance of the sensing unit were conducted. The next tests were used to validate the ability of the unit to perform real-time structural monitoring. The novel concept of employing the computational core of the wireless sensing unit for local data interrogation schemes has been investigated. An FFT has

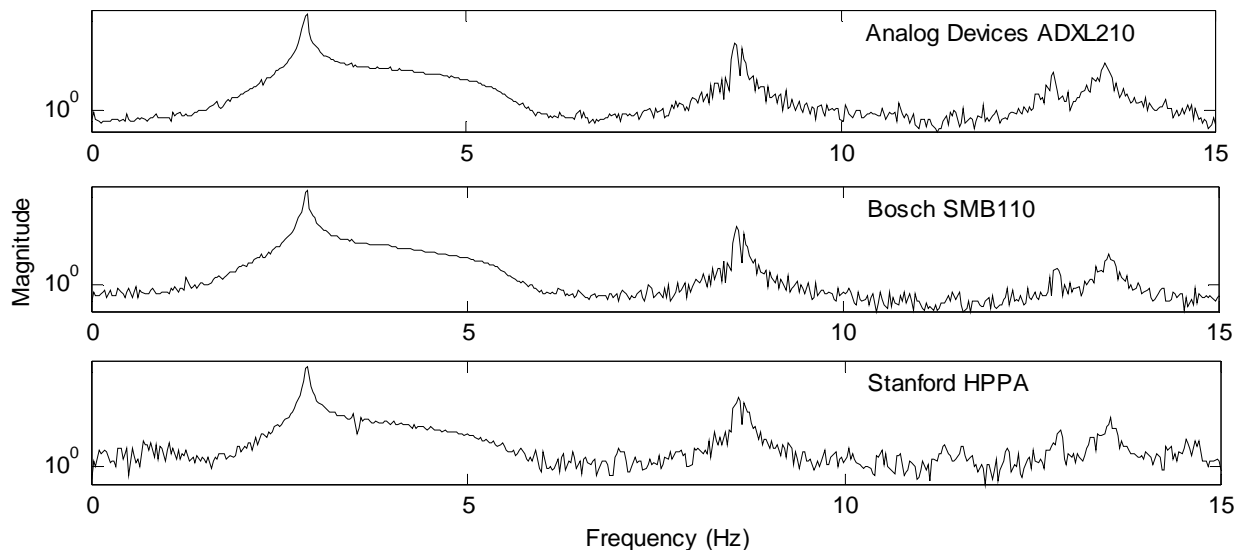


Fig. 12: Locally calculated frequency response function of the 5th story acceleration response

been successfully implemented and the primary modes of response of a structure identified locally by a wireless sensing unit mounted upon a test structure.

Future work is still needed to improve the hardware capabilities of the wireless sensing unit. Particularly, power consumption of the wireless radios is a concern and will be addressed in next generation designs. Furthermore, a more powerful computational core is sought. More power in the core directly translates into more sophisticated data interrogation schemes that can be performed in near real-time with the ultimate goal of incorporating data detection schemes that can hypothesize damage occurrence, location and severity.

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